

/ Descriptions

WR0<50 P M M E SQS æ M ç s ll 1 Silicon PNP transistor in a TO-92LM Plastic Package.

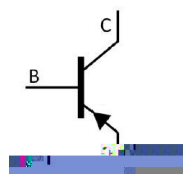
/ Features

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Low saturation voltage, excellent h_{FE} linearity and high h_{FE} .

/ Applications

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Output stage of 3 watts audio amplifier, voltage regulator, DC-DC converter and relay driver.

/ Equivalent Circuit



/ Pinning



PIN1 χ Base PIN 2 χ Collector PIN 3 χ Emitter

/ h_{FE} Classifications & Marking

h_{FE} Classifications Symbol	R	Q	P	E
h_{FE} Range	60 120	100 200	160 320	200 400

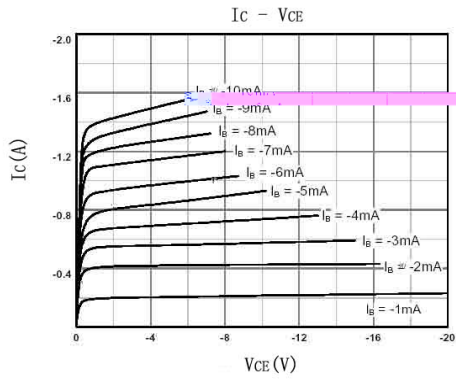
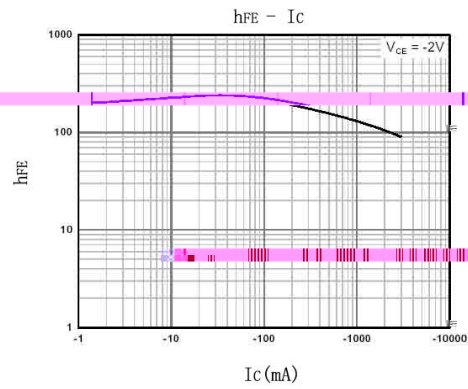
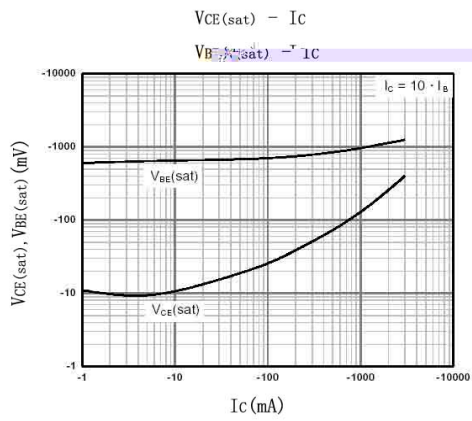
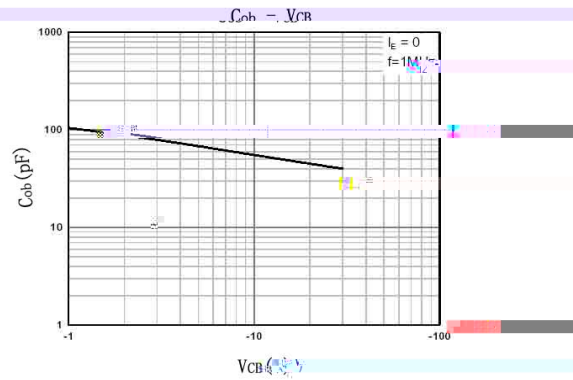
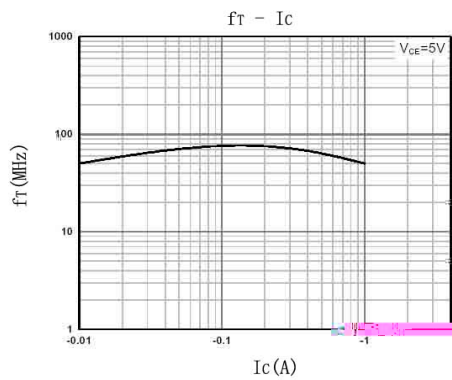
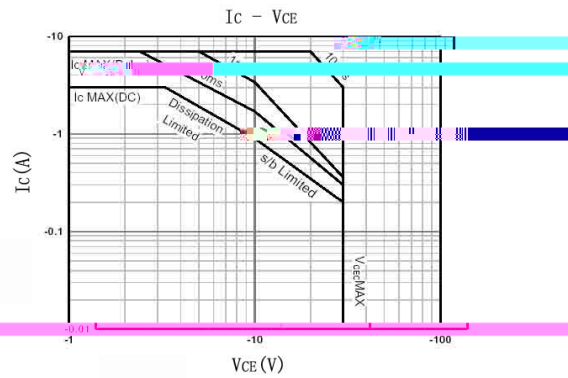
/ Absolute Maximum Ratings(Ta=25 °C)

Parameter	Symbol	Rating	Unit
Collector to Base Voltage	V_{CBO}	-40	V
Collector to Emitter Voltage	V_{CEO}	-30	V
Emitter to Base Voltage	V_{EBO}	-5.0	V
Collector Current (DC)	I_C	-3.0	A
Collector Current(Pulse)	I_{CP}	-7.0	A
Collector Power Dissipation	P_C	1.0	W
Collector Power Dissipation	$P_C(T_C=25^\circ\text{C})$	10	W
Junction Temperature	T_j	150	
Storage Temperature Range	T_{stg}	-55 ~ 150	

/ Electrical Characteristics(Ta=25 °C)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector Cut-Off Current	I_{CBO}	$V_{CB}=-30V$ $I_E=0$			-1.0	μA
Emitter Cut-Off Current	I_{EBO}	$V_{EB}=-3.0V$ $I_C=0$			-1.0	μA
DC Current Gain	$h_{FE(1)}$	$V_{CE}=-2.0V$ $I_C=-1.0A$	60	160	400	
	$h_{FE(2)}$	$V_{CE}=-2.0V$ $I_C=-20mA$	30	220		
Collector to Emitter Saturation Voltage	$V_{CE(sat)}$	$I_C=-2.0A$ $I_B=-0.2A$		-0.3	-0.5	V
Base to Emitter Saturation Voltage	$V_{BE(sat)}$	$I_B=-0.2A$ $I_C=-2.0A$		-1.0	-2.0	V
Transition Frequency	f_T	$I_C=-0.1A$ $V_{CE}=-5.0V$		80		MHz
Collector output capacitance	C_{ob}	$V_{CB}=-10V$ $f=1.0MHz$ $I_E=0$		55		pF

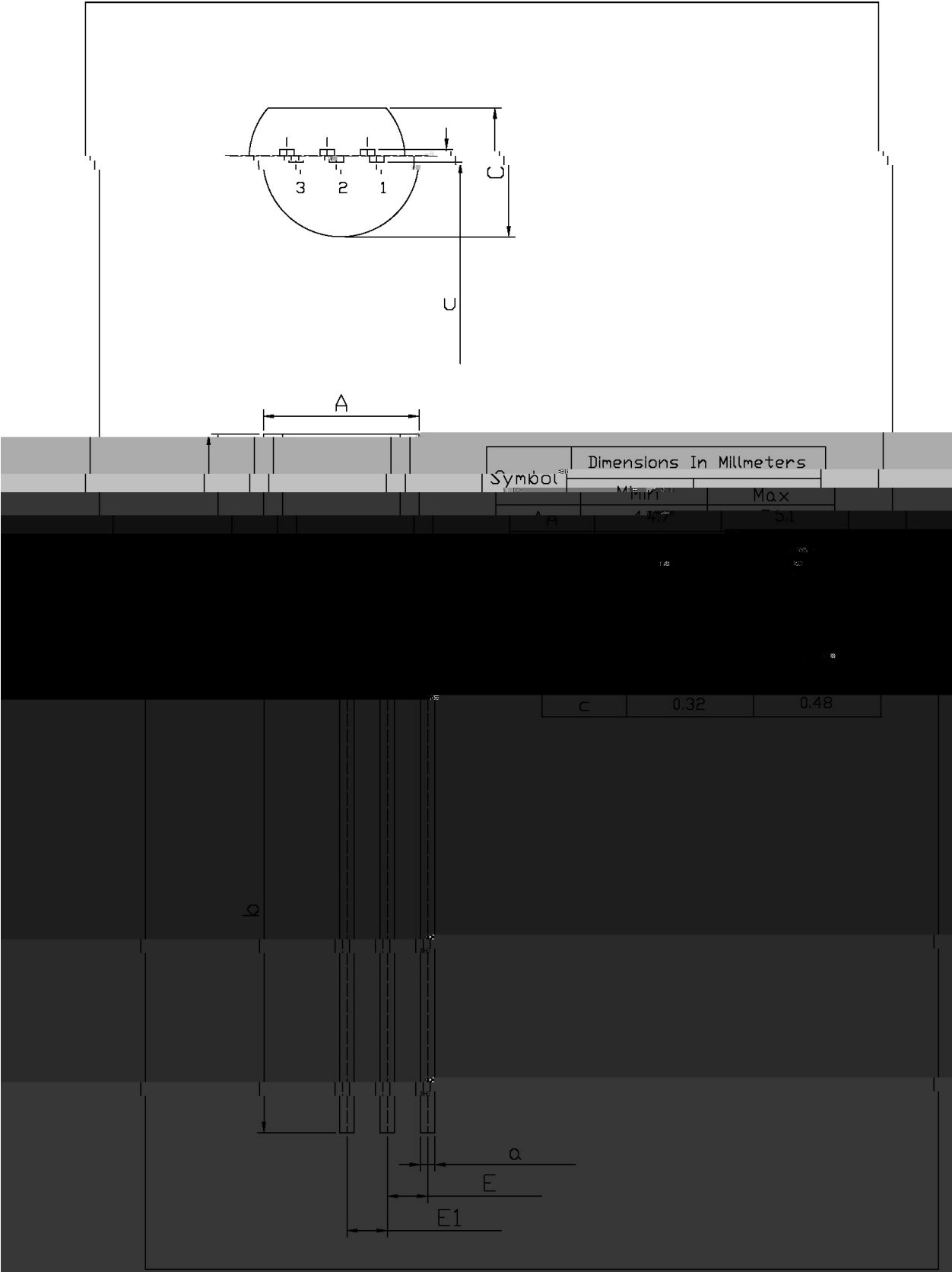
/ Electrical Characteristic Curve



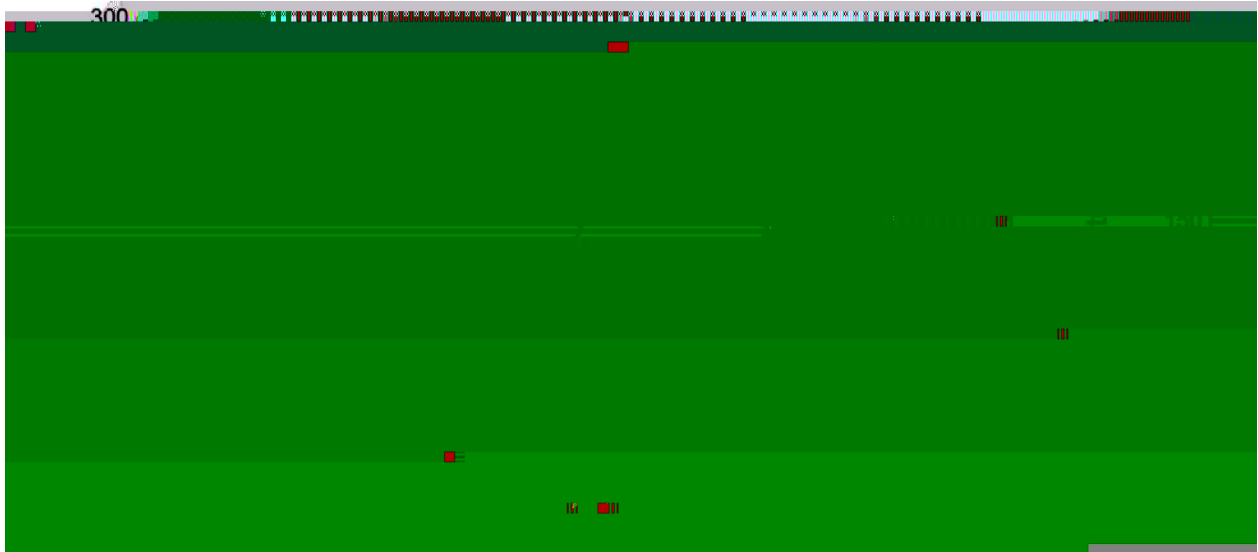
I Package Dimensions

TO-92LM

Unit: mm



() / Temperature Profile for Dip Soldering(Pb-Free)



б " X

1. 1. Preheating: 25~150 °C, Time: 60~90sec;
2. 2. Peak Temp.: 255 °C, Duration: 5 ° 0.5sec;
3. 3. Cooling Speed: 2~10 °C /sec.

Note:

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/ Resistance to Soldering Heat Test Conditions

□ y X 270 ° 5 °C H j X 10 ° 1 sec.

Tf0.56Pb2Tj/TT2 1 Tf2 0 TD-0.0005;